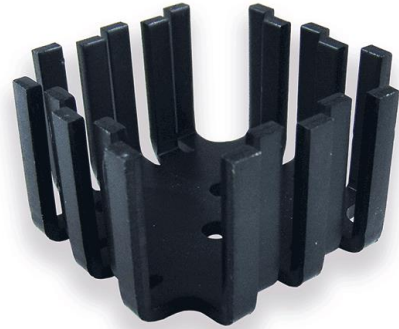


Product Data Sheet Type: FI322/SE

Group: HEATSINKS Board Level

For single mounting

Width :	46 mm
Height :	25.4 mm
Length :	46 mm
Minimum thermal resistance :	6 K/W
For device :	TO 3
Device mounted by :	Screw
Heatsink mounted by :	Srew-On
Surface :	Black Anodised
Material :	Al99,5



Finger shaped heatsink, with hole pattern, for semiconductor case TO3.
Space saving construction.
Turbulence in every installation position

